



Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

E·XFI

Product Status	Active
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	40MHz
Connectivity	I ² C, IrDA, LINbus, PMP, SPI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, I ² S, POR, PWM, WDT
Number of I/O	19
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 3.6V
Data Converters	A/D 9x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mx210f016bt-v-so

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

TABLE 6: PIN NAMES FOR 28-PIN USB DEVICES

28-PIN QFN (TOP VIEW)^(1,2,3,4)

PIC32MX210F016B PIC32MX220F032B PIC32MX230F064B PIC32MX230F256B PIC32MX250F128B PIC32MX250F128B

28

1

Pin #	Full Pin Name	Pin #	Full Pin Name
1	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0	15	TDO/RPB9/SDA1/CTED4/PMD3/RB9
2	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1	16	Vss
3	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2	17	VCAP
4	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3	18	PGED2/RPB10/D+/CTED11/RB10
5	Vss	19	PGEC2/RPB11/D-/RB11
6	OSC1/CLKI/RPA2/RA2	20	VUSB3V3
7	OSC2/CLKO/RPA3/PMA0/RA3	21	AN11/RPB13/CTPLS/PMRD/RB13
8	SOSCI/RPB4/RB4	22	CVREFOUT/AN10/C3INB/RPB14/VBUSON/SCK1/CTED5/RB14
9	SOSCO/RPA4/T1CK/CTED9/PMA1/RA4	23	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15
10	VDD	24	AVss
11	TMS/RPB5/USBID/RB5	25	AVDD
12	VBUS	26	MCLR
13	TDI/RPB7/CTED3/PMD5/INT0/RB7	27	PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0
14	TCK/RPB8/SCL1/CTED10/PMD4/RB8	28	PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1
Note	1: The RPn pins can be used by remappable peripherals. See]	Table 1 for th	e available peripherals and Section 11.3 "Peripheral Pin

1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.

3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.

4: Shaded pins are 5V tolerant.

Referenced Sources

This device data sheet is based on the following individual chapters of the *"PIC32 Family Reference Manual"*. These documents should be considered as the general reference for the operation of a particular module or device feature.

Note:	To access the following documents, refer
	to the Documentation > Reference
	Manuals section of the Microchip PIC32
	website: http://www.microchip.com/pic32

- Section 1. "Introduction" (DS60001127)
- Section 2. "CPU" (DS60001113)
- Section 3. "Memory Organization" (DS60001115)
- Section 5. "Flash Program Memory" (DS60001121)
- Section 6. "Oscillator Configuration" (DS60001112)
- Section 7. "Resets" (DS60001118)
- Section 8. "Interrupt Controller" (DS60001108)
- Section 9. "Watchdog Timer and Power-up Timer" (DS60001114)
- Section 10. "Power-Saving Features" (DS60001130)
- Section 12. "I/O Ports" (DS60001120)
- Section 13. "Parallel Master Port (PMP)" (DS60001128)
- Section 14. "Timers" (DS60001105)
- Section 15. "Input Capture" (DS60001122)
- Section 16. "Output Compare" (DS60001111)
- Section 17. "10-bit Analog-to-Digital Converter (ADC)" (DS60001104)
- Section 19. "Comparator" (DS60001110)
- Section 20. "Comparator Voltage Reference (CVREF)" (DS60001109)
- Section 21. "Universal Asynchronous Receiver Transmitter (UART)" (DS60001107)
- Section 23. "Serial Peripheral Interface (SPI)" (DS60001106)
- Section 24. "Inter-Integrated Circuit (I²C)" (DS60001116)
- Section 27. "USB On-The-Go (OTG)" (DS60001126)
- Section 29. "Real-Time Clock and Calendar (RTCC)" (DS60001125)
- Section 31. "Direct Memory Access (DMA) Controller" (DS60001117)
- Section 32. "Configuration" (DS60001124)
- Section 33. "Programming and Diagnostics" (DS60001129)
- Section 37. "Charge Time Measurement Unit (CTMU)" (DS60001167)

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0			
24.24	R	R	R	R	R	R	R	R			
31:24	BMXPFMSZ<31:24>										
22:16	R	R	R	R	R	R	R	R			
23.10				BMXPFN	ISZ<23:16>						
45.0	R	R	R	R	R	R	R	R			
15:8	BMXPFMSZ<15:8>										
7.0	R	R	R	R	R	R	R	R			
7:0	BMXPFMSZ<7:0>										

REGISTER 4-7: BMXPFMSZ: PROGRAM FLASH (PFM) SIZE REGISTER

Legend:

Legena.			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 BMXPFMSZ<31:0>: Program Flash Memory (PFM) Size bits

Static value that indicates the size of the PFM in bytes: 0x00004000 = Device has 16 KB Flash 0x00008000 = Device has 32 KB Flash 0x00010000 = Device has 64 KB Flash 0x00020000 = Device has 128 KB Flash 0x00040000 = Device has 256 KB Flash

REGISTER 4-8: BMXBOOTSZ: BOOT FLASH (IFM) SIZE REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0				
04.04	R	R	R	R	R	R	R	R				
31:24	BMXBOOTSZ<31:24>											
22.16	R	R	R	R R R		R	R	R				
23.10	BMXBOOTSZ<23:16>											
45.0	R	R	R	R	R	R	R	R				
15:8	BMXBOOTSZ<15:8>											
7.0	R	R	R	R	R	R	R	R				
7:0	BMXBOOTSZ<7:0>											

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 **BMXBOOTSZ<31:0>:** Boot Flash Memory (BFM) Size bits Static value that indicates the size of the Boot PFM in bytes: 0x00000C00 = Device has 3 KB boot Flash

TABLE 7-2: INTERRUPT REGISTER MAP (CONTINUED)

ess		đ		Bits																
Virtual Add (BF88	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets	
1100		31:16	—	—	—		SPI1IP<2:0>		SPI1IS	<1:0>	—	—	—	US	BIP<2:0>(2	:)	USBIS	<1:0> (2)	0000	
1100	IPC/	15:0	-	—	_	(CMP3IP<2:0>	MP3IP<2:0>		CMP3IS<1:0>		_		CN	/IP2IP<2:0>	•	CMP2IS<1:0>		0000	
1110		31:16		—	_		PMPIP<2:0>		PMPIS<1:0>		_	_		C	NIP<2:0>		CNIS	<1:0>	0000	
1110	IFCO	15:0	-	_	-		I2C1IP<2:0>			I2C1IS<1:0>		I2C1IS<1:0> — — U1IP<2:0>		U1IP<2:0>		U1IS	<1:0>	0000		
1120		31:16	-	—	_	(CTMUIP<2:0	>	CTMUIS	S<1:0>	-	_		I2C2IP<2:0>		I2C2IP<2:0>		6<1:0>	0000	
1120	IFC9	15:0	0 — — — U2IP<2		U2IP<2:0>	U2IS<1:0>		U2IS<1:0> —		— — — SPI2IP<2:0>		SPI2IP<2:0>		SPI2IP<2:0>		SPI2IS	6<1:0>	0000		
1100 10010		31:16	—	—	—	[DMA3IP<2:0>	>	DMA3IS	DMA3IS<1:0>)MA3IS<1:0> -		—	_	DMA2IP<2:0>		DMA2I	S<1:0>	0000
1130	IPC10	15:0	_	_	_	[DMA1IP<2:0>	>	DMA1IS	S<1:0>	—	_	—	DN	/A0IP<2:0>	•	DMA0I	S<1:0>	0000	

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: With the exception of those noted, all registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

2: These bits are not available on PIC32MX1XX devices.

3: This register does not have associated CLR, SET, INV registers.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0			
24.24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
31:24		ROTRIM<8:1>									
22:16	R/W-0	R-0	U-0	U-0	U-0	U-0	U-0	U-0			
23:10	ROTRIM<0>	—	—	—	—	—	—	—			
45.0	U-0	R-0	U-0	U-0	U-0	U-0	U-0	U-0			
15:8	—	_	_	_	_	_	—	—			
7.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0			
7:0	_	_	_	_	_	_	_	_			

REGISTER 8-4: REFOTRIM: REFERENCE OSCILLATOR TRIM REGISTER

Legend:

Logonal			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-23 ROTRIM<8:0>: Reference Oscillator Trim bits

Note: While the ON (REFOCON<15>) bit is '1', writes to this register do not take effect until the DIVSWEN bit is also set to '1'.

9.0 DIRECT MEMORY ACCESS (DMA) CONTROLLER

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 31. "Direct Memory Access (DMA) Controller" (DS60001117), which is available from the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32).

The PIC32 Direct Memory Access (DMA) controller is a bus master module useful for data transfers between different devices without CPU intervention. The source and destination of a DMA transfer can be any of the memory mapped modules existent in the PIC32, such as Peripheral Bus devices: SPI, UART, PMP, etc., or memory itself. Figure 9-1 show a block diagram of the DMA Controller module.

The DMA Controller module has the following key features:

- · Four identical channels, each featuring:
 - Auto-increment source and destination address registers
 - Source and destination pointers
 - Memory to memory and memory to peripheral transfers
- Automatic word-size detection:
 - Transfer granularity, down to byte level
 - Bytes need not be word-aligned at source and destination

FIGURE 9-1: DMA BLOCK DIAGRAM

- Fixed priority channel arbitration
- · Flexible DMA channel operating modes:
 - Manual (software) or automatic (interrupt) DMA requests
 - One-Shot or Auto-Repeat Block Transfer modes
 - Channel-to-channel chaining
- · Flexible DMA requests:
 - A DMA request can be selected from any of the peripheral interrupt sources
 - Each channel can select any (appropriate) observable interrupt as its DMA request source
 - A DMA transfer abort can be selected from any of the peripheral interrupt sources
 - Pattern (data) match transfer termination
- Multiple DMA channel status interrupts:
 - DMA channel block transfer complete
 - Source empty or half empty
 - Destination full or half full
 - DMA transfer aborted due to an external event
 - Invalid DMA address generated
- DMA debug support features:
 - Most recent address accessed by a DMA channel
 - Most recent DMA channel to transfer data
- CRC Generation module:
 - CRC module can be assigned to any of the available channels
 - CRC module is highly configurable



TABLE 9-3: DMA CHANNELS 0-3 REGISTER MAP (CONTINUED)

ess										В	its								
Virtual Addre (BF88_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
2000		31:16	_	—	_	-	—	—	_	—	_	—	—	—	—	—	_	—	0000
3280	DCH2CPTR	15:0		CHCPTR<15:0>										0000					
	DOUISDAT	31:16	_	_	_	_	_	_		_	_		_	_	_	_	_		0000
3290	DCH2DAI	15:0			_	_				_		•	•	CHPDA	T<7:0>	•	•		0000
	DOUGOON	31:16	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	0000
32A0	DCH3CON	15:0	CHBUSY	_	_	_	—	—	—	CHCHNS	CHEN	CHAED	CHCHN	CHAEN	—	CHEDET	CHPR	l<1:0>	0000
3280		31:16	—		—	—				—				CHAIR	Q<7:0>				00FF
5260	DCHIJECON	15:0				CHSIR	Q<7:0>	-			CFORCE	CABORT	PATEN	SIRQEN	AIRQEN	—	—	—	FF00
3200	DCH3INT	31:16	—		—	—			—		CHSDIE	CHSHIE	CHDDIE	CHDHIE	CHBCIE	CHCCIE	CHTAIE	CHERIE	0000
0200	DOMONI	15:0	—	—	—	—	—	—		—	CHSDIF	CHSHIF	CHDDIF	CHDHIF	CHBCIF	CHCCIF	CHTAIF	CHERIF	0000
32D0	DCH3SSA	31:16								CHSSA	<31:0>								0000
		15:0																	0000
32E0	DCH3DSA	31:16 15:0								CHDSA	A<31:0>								0000
		31:16	_	_	_	_	—	_	_	_	_	_	—	_	_	—	_	_	0000
32F0	DCH3SSIZ	15:0								CHSSIZ	Z<15:0>								0000
2200		31:16	_	_	—	—	_	_	_	_	_	_	_	_	_	_	_		0000
3300	DCH3DSIZ	15:0								CHDSI	Z<15:0>								0000
3310	оснаертр	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	_	0000
5510	Densor IIX	15:0								CHSPT	R<15:0>								0000
3320	DCH3DPTR	31:16	—	—	—	—	—	—		—	—	—	—	—	—	—	—	—	0000
0020	BOHODI III	15:0								CHDPT	R<15:0>								0000
3330	DCH3CSIZ	31:16	—		—	—	—	—		—	—	—	—	—	—	—	_	—	0000
		15:0								CHCSI	Z<15:0>								0000
3340	DCH3CPTR	31:16	—	_	—	—	_	_	—	-		—	_	_		—	_		0000
		15:0								CHCPT	K<15:0>								0000
3350	DCH3DAT	31:16	_		_	_	_	_		_	_	_	_			—	_		0000
		15.0	_	_	_	_			_	_				CHPDA	11-1.02				0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

PIC32MX1XX/2XX 28/36/44-PIN FAMILY

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	—	—	—	_		—	—	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:10	—	—	—	—	—	—	—	—
45.0	R/W-0	U-0	U-0	R/W-0	R/W-0	U-0	U-0	U-0
15:8	0N ⁽¹⁾	—	_	SUSPEND	DMABUSY	—	—	—
7.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
7:0	_	_	_	_	_	_	_	_

REGISTER 9-1: DMACON: DMA CONTROLLER CONTROL REGISTER

Legend:

•			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

- bit 15 ON: DMA On bit⁽¹⁾
 - 1 = DMA module is enabled
 - 0 = DMA module is disabled
- bit 14-13 **Unimplemented:** Read as '0'
- bit 12 SUSPEND: DMA Suspend bit
 - 1 = DMA transfers are suspended to allow CPU uninterrupted access to data bus
 - 0 = DMA operates normally

bit 11 DMABUSY: DMA Module Busy bit

- 1 = DMA module is active
- 0 = DMA module is disabled and not actively transferring data
- bit 10-0 Unimplemented: Read as '0'
- **Note 1:** When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

14.1 Watchdog Timer Control Registers

TABLE 14-1: WATCHDOG TIMER CONTROL REGISTER MAP

ess		¢,		Bits							6								
Virtual Addr (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
0000		31:16	_	_	-	_	-	-	_	_	—	_	_	_	—	_	_	_	0000
0000	WDICON	15:0	ON	_	—	_	—	_	_	_	_		SI	VDTPS<4:	0>		WDTWINEN	WDTCLR	0000

Legend: x = unknown value on Reset; --- = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

20.0 PARALLEL MASTER PORT (PMP)

Note:	This data sheet summarizes the features
	of the PIC32MX1XX/2XX 28/36/44-pin
	Family of devices. It is not intended to be
	a comprehensive reference source. To
	complement the information in this data
	sheet, refer to Section 13. "Parallel
	Master Port (PMP)" (DS60001128),
	which is available from the Documentation
	> Reference Manual section of the
	Microchip PIC32 web site
	(www.microchip.com/pic32).

The PMP is a parallel 8-bit input/output module specifically designed to communicate with a wide variety of parallel devices, such as communications peripherals, LCDs, external memory devices and microcontrollers. Because the interface to parallel peripherals varies significantly, the PMP module is highly configurable. Key features of the PMP module include:

- Fully multiplexed address/data mode
- Demultiplexed or partially multiplexed address/ data mode
 - up to 11 address lines with single Chip Select
 - up to 12 address lines without Chip Select
- One Chip Select line
- Programmable strobe options
 - Individual read and write strobes or;
 - Read/write strobe with enable strobe
- · Address auto-increment/auto-decrement
- Programmable address/data multiplexing
- Programmable polarity on control signals
- · Legacy parallel slave port support
- · Enhanced parallel slave support
- Address support
- 4-byte deep auto-incrementing buffer
- Programmable Wait states
- · Selectable input voltage levels

Figure 20-1 illustrates the PMP module block diagram.

FIGURE 20-1: PMP MODULE PINOUT AND CONNECTIONS TO EXTERNAL DEVICES



PIC32MX1XX/2XX 28/36/44-PIN FAMILY

REGISTER 20-1: PMCON: PARALLEL PORT CONTROL REGISTER (CONTINUED)

- bit 4 Unimplemented: Read as '0' CS1P: Chip Select 0 Polarity bit⁽²⁾ bit 3 1 = Active-high (PMCS1) $0 = \text{Active-low}(\overline{PMCS1})$ bit 2 Unimplemented: Read as '0' bit 1 WRSP: Write Strobe Polarity bit For Slave Modes and Master mode 2 (MODE<1:0> = 00,01,10): 1 = Write strobe active-high (PMWR) 0 = Write strobe active-low (PMWR) For Master mode 1 (MODE<1:0> = 11): 1 = Enable strobe active-high (PMENB) 0 = Enable strobe active-low (PMENB) bit 0 RDSP: Read Strobe Polarity bit For Slave modes and Master mode 2 (MODE<1:0> = 00,01,10): 1 = Read Strobe active-high (PMRD) $0 = \text{Read Strobe active-low}(\overline{PMRD})$ For Master mode 1 (MODE<1:0> = 11): 1 = Read/write strobe active-high (PMRD/PMWR)
 - 0 = Read/write strobe active-low (PMRD/PMWR)
 - **Note 1:** When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON control bit.
 - 2: These bits have no effect when their corresponding pins are used as address lines.

25.1 CTMU Control Registers

TABLE 25-1: CTMU REGISTER MAP

ess				Bits								6							
Virtual Addr (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Reset
A 200		31:16	EDG1MOD	EDG1POL		EDG15	SEL<3:0>		EDG2STAT	EDG1STAT	EDG2MOD	EDG2POL		EDG28	SEL<3:0>		_	—	0000
A200	CINOCON	15:0	ON	—	CTMUSIDL	TGEN	EDGEN	EDGSEQEN	IDISSEN	CTTRIG			ITRIM•	<5:0>			IRNG	<1:0>	0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

						0				
Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
24.04	R/P	R/P	R/P	R/P	r-1	r-1	r-1	r-1		
31:24	FVBUSONIO	FUSBIDIO	IOL1WAY	PMDL1WAY	—		—	_		
00.40	r-1	r-1	r-1	r-1	r-1	r-1	r-1	r-1		
23.10	—	—	—	—	—	—	—	-		
15.0	R/P	R/P	R/P	R/P	R/P	R/P	R/P	R/P		
15:8	USERID<15:8>									
7:0	R/P	R/P	R/P	R/P	R/P	R/P	R/P	R/P		
7.0				USERID<	7:0>					

REGISTER 27-4: DEVCFG3: DEVICE CONFIGURATION WORD 3

Legend:	r = Reserved bit	P = Programmable bit
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

bit 31 FVBUSONIO: USB VBUSON Selection bit

- 1 = VBUSON pin is controlled by the USB module 0 = VBUSON pin is controlled by the port function
- bit 30 **FUSBIDIO:** USB USBID Selection bit 1 = USBID pin is controlled by the USB module 0 = USBID pin is controlled by the port function
- bit 29 IOL1WAY: Peripheral Pin Select Configuration bit
 - 1 = Allow only one reconfiguration
 - 0 = Allow multiple reconfigurations
- bit 28 PMDI1WAY: Peripheral Module Disable Configuration bit
 - 1 = Allow only one reconfiguration
 - 0 = Allow multiple reconfigurations
- bit 27-16 Reserved: Write '1'
- bit 15-0 USERID<15:0>: User ID bits

This is a 16-bit value that is user-defined and is readable via ICSP™ and JTAG.

TABLE 30-37: PARALLEL SLAVE PORT REQUIREMENTS

AC CHARACTERISTICS			$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$						
Para m.No.	Symbol	Characteristics ⁽¹⁾	Min.	Тур.	Max.	Units	Conditions		
PS1	TdtV2wr H	Data In Valid before \overline{WR} or \overline{CS} Inactive (setup time)	20			ns	_		
PS2	TwrH2dt I	WR or CS Inactive to Data-In Invalid (hold time)	40		—	ns	—		
PS3	TrdL2dt V	RD and CS Active to Data-Out Valid	—		60	ns	—		
PS4	TrdH2dtl	RD Active or CS Inactive to Data-Out Invalid	0	_	10	ns	—		
PS5	Tcs	CS Active Time	Трв + 40		—	ns	—		
PS6	TwR	WR Active Time	Трв + 25		_	ns	_		
PS7	Trd	RD Active Time	Трв + 25	_	_	ns	_		

Note 1: These parameters are characterized, but not tested in manufacturing.

FIGURE 30-21: PARALLEL MASTER PORT READ TIMING DIAGRAM



NOTES:

28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS					
Dimensior	MIN	NOM	MAX			
Contact Pitch	E	0.65 BSC				
Optional Center Pad Width	W2			4.25		
Optional Center Pad Length	T2			4.25		
Contact Pad Spacing	C1		5.70			
Contact Pad Spacing	C2		5.70			
Contact Pad Width (X28)	X1			0.37		
Contact Pad Length (X28)	Y1			1.00		
Distance Between Pads	G	0.20				

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2105A

PIC32MX1XX/2XX 28/36/44-PIN FAMILY

44-Terminal Very Thin Leadless Array Package (TL) – 6x6x0.9 mm Body With Exposed Pad [VTLA]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging





DETAIL A

	MILLIMETERS				
Dimension	Limits	MIN	NOM	MAX	
Number of Pins	N		44	-	
Number of Pins per Side	ND		12		
Number of Pins per Side	NE		10		
Pitch	е	0.50 BSC			
Overall Height	A	0.80	0.90	1.00	
Standoff	A1	0.025	-	0.075	
Overall Width	E		6.00 BSC		
Exposed Pad Width	E2	4.40	4.55	4.70	
Overall Length	D		6.00 BSC	-	
Exposed Pad Length	D2	4.40	4.55	4.70	
Contact Width	b	0.20	0.25	0.30	
Contact Length	L	0.20	0.25	0.30	
Contact-to-Exposed Pad	K	0.20	_	-	

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated.

3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-157C Sheet 2 of 2

44-Lead Plastic Quad Flat, No Lead Package (ML) – 8x8 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS				
Dimension	MIN	NOM	MAX		
Contact Pitch	E		0.65 BSC		
Optional Center Pad Width	W2			6.80	
Optional Center Pad Length	T2			6.80	
Contact Pad Spacing	C1		8.00		
Contact Pad Spacing	C2		8.00		
Contact Pad Width (X44)	X1			0.35	
Contact Pad Length (X44)	Y1			0.80	
Distance Between Pads	G	0.25			

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2103A

Revision F (February 2014)

This revision includes the addition of the following devices:

In addition, this revision includes the following major changes as described in Table A-5, as well as minor updates to text and formatting, which were incorporated throughout the document.

- PIC32MX170F256B PIC32MX270F256B
- PIC32MX170F256D
 PIC32MX270F256D

TABLE A-5: MAJOR SECTION UPDATES

Section	Update Description
32-bit Microcontrollers (up to 256	Added new devices to the family features (see Table 1 and Table 2).
KB Flash and 64 KB SRAM) with	Updated pin diagrams to include new devices (see "Pin Diagrams").
Audio and Graphics Interfaces, USB, and Advanced Analog	
1.0 "Device Overview"	Added Note 3 reference to the following pin names: VBUS, VUSB3V3, VBUSON,
	D+, D-, and USBID.
2.0 "Guidelines for Getting	Replaced Figure 2-1: Recommended Minimum Connection.
Started with 32-bit MCUs"	Updated Figure 2-2: MCLR Pin Connections.
	Added 2.9 "Sosc Design Recommendation".
4.0 "Memory Organization"	Added memory tables for devices with 64 KB RAM (see Table 4-4 through Table 4-5).
	Changed the Virtual Addresses for all registers and updated the PWP bits in the DEVCFG: Device Configuration Word Summary (see Table 4-17).
	Updated the ODCA, ODCB, and ODCC port registers (see Table 4-19, Table 4-20, and Table 4-21).
	The RTCTIME, RTCDATE, ALRMTIME, and ALRMDATE registers were updated (see Table 4-25).
	Added Data Ram Size value for 64 KB RAM devices (see Register 4-5).
	Added Program Flash Size value for 256 KB Flash devices (see Register 4-5).
12.0 "Timer1"	The Timer1 block diagram was updated to include the 16-bit data bus (see Figure 12-1).
13.0 "Timer2/3, Timer4/5"	The Timer2-Timer5 block diagram (16-bit) was updated to include the 16-bit data bus (see Figure 13-1).
	The Timer2/3, Timer4/5 block diagram (32-bit) was updated to include the 32- bit data bus (see Figure 13-1).
19.0 "Parallel Master Port (PMP)"	The CSF<1:0> bit value definitions for '00' and '01' were updated (see Register 19-1).
	Bit 14 in the Parallel Port Address register (PMADDR) was updated (see Register 19-3).
20.0 "Real-Time Clock and	The following registers were updated:
Calendar (RTCC)"	RTCTIME (see Register 20-3)
	RTCDATE (see Register 20-4)
	ALRMTIME (see Register 20-5)
	ALRMDATE (see Register 20-6)
26.0 "Special Features"	Updated the PWP bits (see Register 26-1).
29.0 "Electrical Characteristics"	Added parameters DO50 and DO50a to the Capacitive Loading Requirements on Output Pins (see Table 29-14).
	Added Note 5 to the IDD DC Characteristics (see Table 29-5).
	Added Note 4 to the IIDLE DC Characteristics (see Table 29-6).
	Added Note 5 to the IPD DC Characteristics (see Table 29-7).
	Updated the conditions for parameters USB321 (VOL) and USB322 (VOH) in the OTG Electrical Specifications (see Table 29-38).
Product Identification System	Added 40 MHz speed information.

Revision G (April 2015)

This revision includes the addition of the following devices:

- PIC32MX130F256B
 PIC32MX230F256B
- PIC32MX130F256D PIC32MX230F256D

The title of the document was updated to avoid confusion with the PIC32MX1XX/2XX/5XX 64/100-pin Family data sheet.

TABLE A-6: MAJOR SECTION UPDATES

All peripheral SFR maps have been relocated from the Memory chapter to their respective peripheral chapters.

In addition, this revision includes the following major changes as described in Table A-6, as well as minor updates to text and formatting, which were incorporated throughout the document.

Section	Update Description
32-bit Microcontrollers (up to 256 KB Flash and 64 KB SRAM) with Audio and Graphics Interfaces, USB, and Advanced Analog	Added new devices to the family features (see Table 1 and Table 2). Updated pin diagrams to include new devices (see Pin Diagrams).
2.0 "Guidelines for Getting Started with 32-bit MCUs"	Updated these sections: 2.2 "Decoupling Capacitors", 2.3 "Capacitor on Internal Voltage Regulator (VCAP)", 2.4 "Master Clear (MCLR) Pin", 2.8.1 "Crystal Oscillator Design Consideration"
4.0 "Memory Organization"	Added Memory Map for new devices (see Figure 4-6).
14.0 "Watchdog Timer (WDT)"	New chapter created from content previously located in the Special Features chapter.
30.0 "Electrical Characteristics"	Removed parameter D312 (TSET) from the Comparator Specifications (see Table 30-12).
	Added the Comparator Voltage Reference Specifications (see Table 30-13).
	Updated Table 30-12.

Revision H (July 2015)

This revision includes the following major changes as described in Table A-7, as well as minor updates to text and formatting, which were incorporated throughout the document.

TABLE A-7: MAJOR SECTION UPDATES

Section	Update Description
2.0 "Guidelines for Getting Started with 32-bit MCUs"	Section 2.9 "Sosc Design Recommendation" was removed.
8.0 "Oscillator Configuration"	The Primary Oscillator (Posc) logic in the Oscillator diagram was updated (see Figure 8-1).
30.0 "Electrical Characteristics"	The Power-Down Current (IPD) DC Characteristics parameter DC40k was updated (see Table 30-7).
	Table 30-9: "DC Characteristics: I/O Pin Input Injection current Specifications" was added.